# Power MOSFET –30V, 303mΩ, –1.6A, Single P-Channel

This Power MOSFET is produced using ON Semiconductor's trench technology, which is specifically designed to minimize gate charge and low on resistance. This device is suitable for applications with low gate charge driving or low on resistance requirements.

#### **Features**

- High Speed Switching
- 4V drive
- Pb-Free, Halogen Free and RoHS compliance

#### **Typical Applications**

• DC/DC Converter

#### **SPECIFICATIONS**

ABSOLUTE MAXIMUM RATING at Ta = 25°C (Note 1, 2)

Parameter	Symbol	Value	Unit
Drain to Source Voltage	VDSS	-30	V
Gate to Source Voltage	VGSS	±20	V
Drain Current (DC)	ID	-1.6	Α
Drain Current (Pulse) PW ≤ 10µs, duty cycle ≤ 1%	IDP	-6.4	Α
Power Dissipation When mounted on ceramic substrate (900mm²×0.8mm)	PD	0.9	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55 to +150	°C

- Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
  - 2 : This product is designed to "ESD immunity<200V\*", so please take care when handling.
    - \*Machine Model

#### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit		
Junction to Ambient When mounted on ceramic substrate (900mm²×0.8mm)	R <sub>θ</sub> JA	138.8	°C/W		

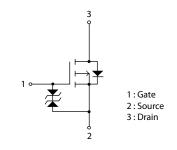


#### ON Semiconductor®

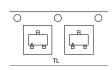
www.onsemi.com

VDSS	R <sub>DS</sub> (on) Max	I <sub>D</sub> Max	
	303mΩ@ –10V		
-30V	532mΩ@ -4.5V	-1.6A	
	617mΩ@ –4V		

## ELECTRICAL CONNECTION P-Channel



#### PACKING TYPE: TL MARKING





#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 5 of this data sheet.

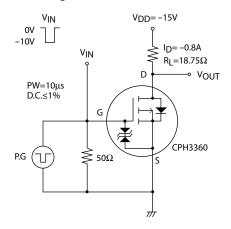
#### **ELECTRICAL CHARACTERISTICS** at Ta = 25°C (Note 3)

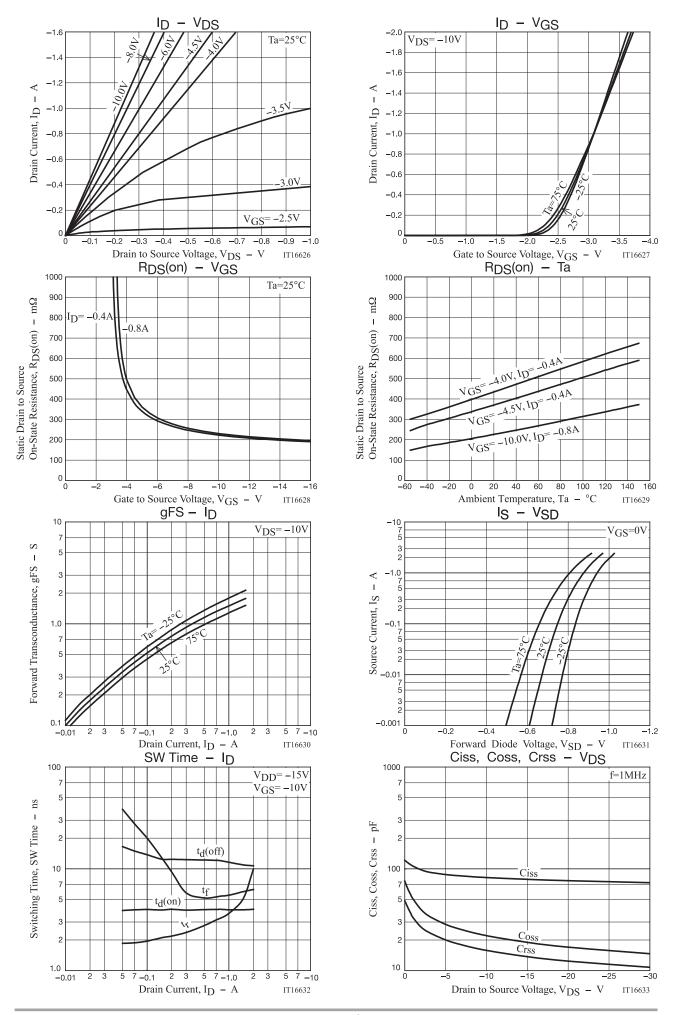
Parameter	Symbol	Conditions	Value			Unit	
Farameter	Syllibol	Conditions	min	typ	max	Ullit	
Drain to Source Breakdown Voltage	V(BR)DSS	ID=-1mA, VGS=0V	-30			V	
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V			-1	μА	
Gate to Source Leakage Current	IGSS	V <sub>GS</sub> =±16V, V <sub>DS</sub> =0V			±10	μΑ	
Gate Threshold Voltage	VGS(th)	V <sub>DS</sub> =-10V, I <sub>D</sub> =-1mA	-1.2		-2.6	V	
Forward Transconductance	gFS	V <sub>DS</sub> =-10V, I <sub>D</sub> =-0.8A		1.3		S	
	R <sub>DS</sub> (on)1	I <sub>D</sub> =-0.8A, V <sub>G</sub> S=-10V		233	303	mΩ	
Static Drain to Source On-State	R <sub>DS</sub> (on)2	I <sub>D</sub> =-0.4A, V <sub>G</sub> S=-4.5V		380	532	mΩ	
Resistance	RDS(on)3	ID=-0.4A, VGS=-4V		441	617	mΩ	
Input Capacitance	Ciss			82		pF	
Output Capacitance	Coss	V <sub>DS</sub> =-10V, f=1MHz		22		pF	
Reverse Transfer Capacitance	Crss			16		pF	
Turn-ON Delay Time	t <sub>d</sub> (on)			4.0		ns	
Rise Time	t <sub>r</sub>			3.3		ns	
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit		12		ns	
Fall Time	tf			5.4		ns	
Total Gate Charge	Qg			2.2		nC	
Gate to Source Charge	Qgs	V <sub>DS</sub> =-15V, V <sub>GS</sub> =-10V, I <sub>D</sub> =-1.6A		0.36		nC	
Gate to Drain "Miller" Charge	Qgd			0.49		nC	
Forward Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> =-1.6A, V <sub>G</sub> S=0V		-0.9	-1.5	V	

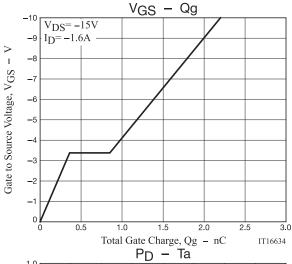
Forward Diode Voltage VSD IS=-1.6A, VGS=0V -0.9 -1.5 V

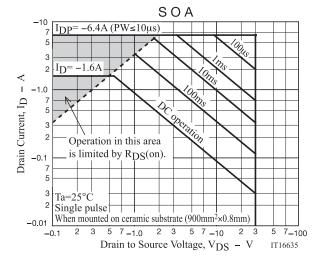
Note 3 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

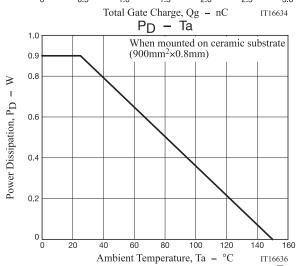
#### **Switching Time Test Circuit**

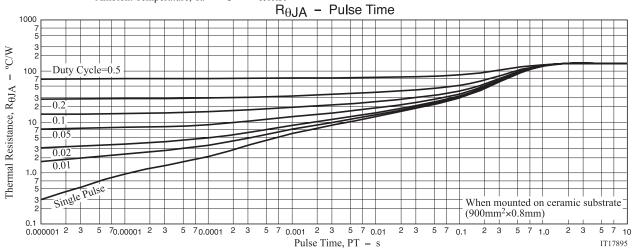






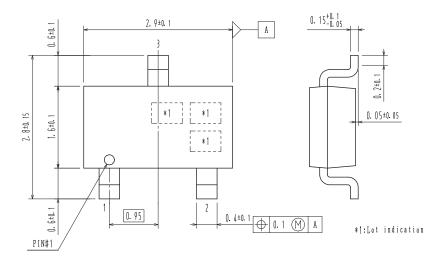






#### PACKAGE DIMENSIONS

Unit: mm CPH3 CASE 318BA ISSUE O



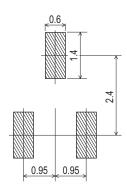
# 0.0 9 ± 0.0 0 0.2

1 : Gate

2 : Source

3: Drain

#### Recommended Soldering Footprint



#### ORDERING INFORMATION

Device	Marking	Package	Shipping (Qty / Packing)	
CPH3360-TL-H	ws	CPH3 SC-59, SOT-23, TO-236	2 000 / Topo & Dool	
CPH3360-TL-W			3,000 / Tape & Reel	

<sup>†</sup> For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub\_link/Collateral/BRD8011-D.PDF

Note on usage: Since the CPH3360 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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